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Low Skew Fan Out Buffers

General Description

The ICS9179-03 generates low skew clock buffers required for high speed RISC or CISC microprocessor systems such as Intel PentiumPro. Outputs will handle up to 133MHz clocks. An output enable is provided for testability.

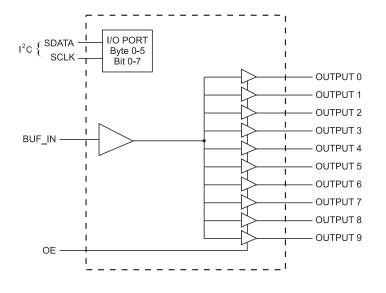
The device is a buffer with low output to output skew. This is a Fanout buffer device, not using an internal PLL. This buffer can also be a feedback to an external PLL stage for phase synchronization to a master clock. There are a total of ten outputs, sufficient for feedback to a PLL source and to drive four small outline DIMM modules (S.O. DIMM) at 2 clocks each. Or a total of ten outputs as a Fanout buffer from a common clock source.

The individual clock outputs are addressable through I²C to be enabled, or stopped in a low state for reduced EMI when the lines are not needed.

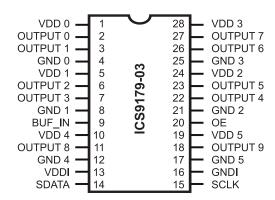
Features

- Ten High speed, low noise non-inverting buffers for (to 133MHz), clock buffer applications.
- Output slew rate faster than 1.5V/ns into 20pF
- Supports up to four small outline DIMMS (S.O. DIMM).
- Synchronous clocks skew matched to 250 ps window on OUTPUTs (0:9).
- I²C Serial Configuration interface to allow individual OUTPUTs to be stopped low.
- Multiple VDD, VSS pins for noise reduction
- Tri-state pin for testing
- 3.0V 3.7V supply range
- 28-pin (209 mil) SSOP and (6.1mm) TSSOP package

Block Diagram



Pin Configuration



28-Pin SSOP & TSSOP



Pin Descriptions

PIN NUMBER	PIN NAME	TYPE	DESCRIPTION
2, 3	OUTPUT (0:1)	OUT	Clock outputs ¹ , uses VDD0, GND0
6, 7	OUTPUT (2:3)	OUT	Clock outputs ¹ , uses VDD1, GND1
22, 23	OUTPUT (4:5)	OUT	Clock outputs ¹ uses VDD2, GND2
26, 27	OUTPUT (6:7)	OUT	Clock output ¹ uses VDD3, GND3
11	OUTPUT8	OUT	Clock output¹ uses VDD4, GND4
18	OUTPUT9	OUT	Clock output ¹ uses VDD5, GND5
9	BUF_IN	IN	Input for buffers
20	OE	IN	Tri-states all outputs when held LOW. Has internal pull-up. ²
14	SDATA	I/O	Data pin for I ² C circuitry ³
15	SCLK	I/O	Clock pin for I ² C circuitry ³
1, 5, 10, 19, 24, 28	VDD (0:5)	PWR	3.3V Power supply for OUTPUT buffers
4, 8, 12, 16, 17, 21, 25	GND (0:5)	PWR	Ground for OUTPUT buffers
13	VDDI	PWR	3.3V Power supply for I ² C circuitry and internal logic
16	GNDI	PWR	Ground for I ² C circuitry and internal logic

Notes:

- 1. At power up all ten OUTPUTs are enabled and active.
- 2. OE has a 100K Ohm internal pull-up resistor to keep all outputs active.
- 3. The SDATA and SCLK inputs both also have internal pull-up resistors with values above 100K Ohms as well for complete platform flexibility.

Power Groups

VDD (0:5), GND (0:5) = Power supply for OUTPUT buffer VDDI, GNDI = Power supply for I^2C circuitry



Technical Pin Function Descriptions

VDD

This is the power supply to the internal core logic of the device as well as the clock output buffers for OUTPUT (0:9).

This pin operates at 3.3V volts. Clocks from the listed buffers that it supplies will have a voltage swing from Ground to this level. For the actual guaranteed high and low voltage levels for the Clocks, please consult the DC parameter table in this data sheet.

GND

This is the power supply ground (common or negative) return pin for the internal core logic and all the output buffers.

OUTPUT (0:9)

These Output Clocks are use to drive Dynamic RAM's and are low skew copies of the CPU Clocks. The voltage swing of the OUTPUTs output is controlled by the supply voltage that is applied to VDD of the device, operates at 3.3 volts.

I^2C

The SDATA and SCLOCK Inputs are use to program the device. The clock generator is a slave-receiver device in the I²C protocol. It will allow read-back of the registers. See configuration map for register functions. The I²C specification in Philips I²C Peripherals Data Handbook (1996) should be followed.

BUF IN

Input for Fanout buffers (OUTPUT 0:9).

OF

OE tristates all outputs when held low.

VDD1

This is the power supply to I^2C circuitry.



General I²C serial interface information

The information in this section assumes familiarity with I²C programming.

How to Write:

- Controller (host) sends a start bit.
- Controller (host) sends the write address D2 (H)
- ICS clock will *acknowledge*
- Controller (host) sends a dummy command code
- ICS clock will acknowledge
- Controller (host) sends a dummy byte count
- ICS clock will acknowledge
- Controller (host) starts sending first byte (Byte 0) through byte 5
- ICS clock will *acknowledge* each byte *one at a time*.

How to Write:					
Controller (Host)	ICS (Slave/Receiver)				
Start Bit					
Address					
D2 _(H)					
	ACK				
Dummy Command Code					
	ACK				
Dummy Byte Count					
	ACK				
Byte 0					
	ACK				
Byte 1					
	ACK				
Byte 2					
	ACK				
Byte 3					
	ACK				
Byte 4					
	ACK				
Byte 5					
	ACK				
Byte 6					
	ACK				
Stop Bit					

How to Read:

- Controller (host) will send start bit.
- Controler (host) sends the read address D3 (H)
- ICS clock will acknowledge
- ICS clock will send the byte count
- Controller (host) acknowledges
- ICS clock sends first byte (Byte 0) through byte 6
- · Controller (host) will need to acknowledge each byte
- Controller (host) will send a stop bit

How to Read:					
Controller (Host) ICS (Slave/Receiver					
Start Bit					
Address					
D3 _(H)					
	ACK				
	Byte Count				
ACK					
	Byte 0				
ACK					
	Byte 1				
ACK					
	Byte 2				
ACK					
	Byte 3				
ACK					
	Byte 4				
ACK	_				
	Byte 5				
ACK					
	Byte 6				
ACK					
Stop Bit					

Notes:

- 1. The ICS clock generator is a slave/receiver, I²C component. It can read back the data stored in the latches for verification. **Read-Back will support Intel PIIX4** "**Block-Read**" **protocol**.
- 2. The data transfer rate supported by this clock generator is 100K bits/sec or less (standard mode)
- 3. The input is operating at 3.3V logic levels.
- 4. The data byte format is 8 bit bytes.
- 5. To simplify the clock generator I²C interface, the protocol is set to use only "Block-Writes" from the controller. The bytes must be accessed in sequential order from lowest to highest byte with the ability to stop after any complete byte has been transferred. The Command code and Byte count shown above must be sent, but the data is ignored for those two bytes. The data is loaded until a Stop sequence is issued.
- 6. At power-on, all registers are set to a default condition, as shown.



Serial Configuration Command Bitmaps

Byte 0: OUTPUT Clock Register (Default=0)

BIT	PIN#	PWD	DESCRIPTION
Bit7	-	1	Reserved
Bit6	-	1	Reserved
Bit5	-	1	Reserved
Bit4	-	1	Reserved
Bit3	7	1	OUTPUT3
Bit2	6	1	OUTPUT2
Bit1	3	1	OUTPUT1
Bit0	2	1	OUTPUT0

Notes: 1 = Enabled; 0 = Disabled, outputs held low

Note: PWD = Power-Up Default

Byte 1: OUTPUT Clock Register

BIT	PIN#	PWD	DESCRIPTION
Bit 7	27	1	OUTPUT7 (Act/Inact)
Bit 6	26	1	OUTPUT6 (Act/Inact)
Bit 5	23	1	OUTPUT5 (Act/Inact)
Bit 4	22	1	OUTPUT4 (Act/Inact)
Bit 3	-	1	Reserved
Bit 2	-	1	Reserved
Bit 1	-	1	Reserved
Bit 0	-	1	Reserved

Notes: 1 = Enabled; 0 = Disabled, outputs held low

Note: PWD = Power-Up Default

Byte 2: OUTPUT Clock Register

byte 2. OUTPUT Clock negister						
BIT	PIN#	PWD	DESCRIPTION			
Bit 7	18	1	OUTPUT9 (Act/Inact)			
Bit 6	11	1	OUTPUT8 (Act/Inact)			
Bit 5	-	1	Reserved			
Bit 4	-	1	Reserved			
Bit 3	-	1	Reserved			
Bit 2	-	1	Reserved			
Bit 1	-	1	Reserved			
Bit 0	-	1	Reserved			

Notes: 1 = Enabled; 0 = Disabled, outputs held low

ICS9179-03 Power Management

The values below are estimates of target specifications.

Condition	Max 3.3V supply consumption Max discrete cap loads VDD = 3.465V All static inputs = VDD or GND	
No Clock Mode (BUF_IN - VDD1 or GND) I ² C Circuitry Active	3mA	
Active 66MHz (BUF_IN = 66.66MHz)	230mA	
Active 100MHz (BUF_IN = 100.00MHz)	360mA	
Active 133MHz (BUF_IN = 133.33MHz)	460mA	

Functionality

i dilottorit	anotionanty					
OE#	OUTPUT (0:9)					
0	Hi-Z					
1	1 X BUF_IN					



Absolute Maximum Ratings

Supply Voltage 7.0 V

Logic Inputs GND –0.5 V to V_{DD} +0.5 V

Ambient Operating Temperature 0° C to +70°C

Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input High Voltage	V_{IH}		2		V _{DD} +0.3	V
Input Low Voltage	$ m V_{IL}$		V_{SS} -0.3		0.8	V
Input High Current	${ m I}_{ m IH}$	$V_{\rm IN} = V_{\rm DD}$			5	uA
Input Low Current	${ m I}_{ m IL}$	$V_{IN} = 0$ V; Inputs with no pull-up resistors	-5			uA
	${ m I}_{ m IL}$	$V_{IN} = 0$ V; Inputs with 100K pull-up resistors	-60	-33		uA
	I_{DD1}	$C_L = 0 \text{ pF; } F_{IN} @ 66M$		80	120	mA
Operating	I_{DD2}	$C_L = 0 \text{ pF; } F_{IN} @ 100M$		120	180	mA
	I_{DD3}	$C_L = 0 \text{ pF; } F_{IN} @ 133M$		170	240	mA
Supply Current	I_{DD4}	$C_L = 30 \text{ pF}; \text{ RS}=33\Omega; F_{IN} @ 66M$		180	260	mA
	I_{DD5}	$C_L = 30 \text{ pF}; \text{ RS}=33\Omega; F_{IN} @ 100M$		240	360	mA
	I_{DD6}	$C_L = 30 \text{ pF}; \text{ RS}=33\Omega; F_{IN} @ 133M$		350	460	mA
Input frequency	$F_i^{\ 1}$	V _{DD} = 3.3 V; All Outputs Loaded	10		133	MHz
Input Capacitance	C_{IN}^{-1}	Logic Inputs			5	pF

¹Guarenteed by design, not 100% tested in production.



Electrical Characteristics - Outputs

 $T_A = 0 - 70C$; $V_{DD} = 3.3 \text{ V +/-5\%}$; $C_L = 20 - 30 \text{ pF (unless otherwise stated)}$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Impedance	R_{DSP}	$V_{\rm O} = V_{\rm DD}^*(0.5)$	10		24	Ω
Output Impedance	R_{DSN}	$V_{\rm O} = V_{\rm DD}^*(0.5)$	10		24	Ω
Output High Voltage	V_{OH}	$I_{OH} = -30 \text{ mA}$	2.3	3		V
Output Low Voltage	V_{OL}	$I_{OL} = 23 \text{ mA}$		0.27	0.4	V
Output High Current	I_{OH}	$V_{OH} = 2.0 \text{ V}$		-115	-54	mA
Output Low Current	I_{OL}	$V_{OL} = 0.8 \text{ V}$	40	57		mA
Rise Time ¹	T_{r}	$V_{OL} = 0.4 \text{ V}, V_{OH} = 2.4 \text{ V}$	0.5	0.95	1.33	ns
Fall Time ¹	T_{f}	$V_{OH} = 2.4 \text{ V}, V_{OL} = 0.4 \text{ V}$	0.5	0.95	1.33	ns
Duty Cycle ¹	D_t	$V_T = 1.5 \text{ V}$	45	50	55	%
Skew ¹	T_{sk}	$V_T = 1.5 \text{ V}$		110	250	ps
	T_{PHL1}	$V_T = 1.5 \text{ V}$	1	5.2	5.5	ns
	T_{PLH1}	$V_T = 1.5 \text{ V}$	1	5.2	5.5	ns
Propagation ^{1,2}	T_{PHL2}	50% Buffer In to 90% Out	1	4.3	5	ns
	T_{PLH2}	50% Buffer In to 10% Out	1	4.3	5	ns
	T_{EN}	$V_T = 1.5 \text{ V}$	1		8	ns
	T_{DIS}	$V_T = 1.5 \text{ V}$	1		8	ns

Note1: Paramater is guaranteed by design and characterization for all operating frequencies, (10 MHz - 133 MHz). Not 100% tested in production

Note2: Duty cycle of input clock is 47.5% to 52.5%. Input edge rate is for propagation delay $\geq 1V/ns$

ICS9179-03



General Layout Precautions:

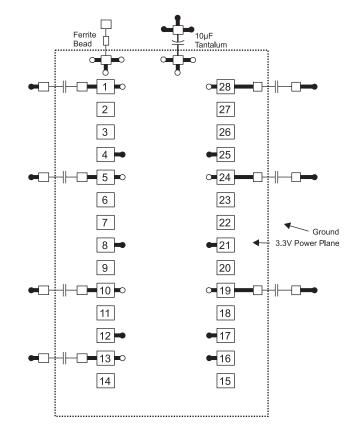
- 1) Use a ground plane on the top layer of the PCB in all areas not used by traces.
- 2) Make all power traces and vias as wide as possible to lower inductance.

Notes:

- 1 All clock outputs should have series terminating resistor. Not shown in all places to improve readibility of diagram
- 2 Optional EMI capacitor should be used on all CPU, SDRAM, and PCI outputs.

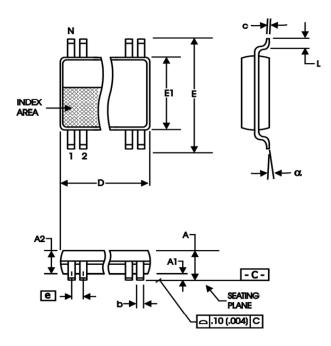
Capacitor Values:

All unmarked capacitors are 0.01 µF ceramic



- = Ground Plane Connection
- = Power Plane Conncetion
- ☐ = Solder Pads





209 mil SSOP

209 mil SSOP

				-	
	In Milli	meters	In Inches		
SYMBOL	COMMON D	IMENSIONS	COMMON DIMENSIONS		
	MIN	MAX	MIN	MAX	
Α	-	2.00		.079	
A1	0.05	-	.002		
A2	1.65	1.85	.065	.073	
b	0.22	0.38	.009	.015	
С	0.09	0.25	.0035	.010	
D	SEE VARIATIONS		SEE VARIATIONS		
Е	7.40	8.20	.291	.323	
E1	5.00	5.60	.197	.220	
е	0.65 E	BASIC	0.0256 BASIC		
L	0.55	0.95	.022	.037	
N	SEE VAF	SEE VARIATIONS		RIATIONS	
α	0°	8°	0°	8°	

VARIATIONS

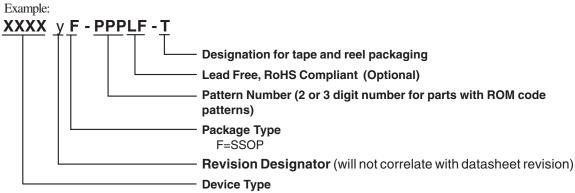
N	Dm	nm.	D (ir	nch)
IN IN	MIN	MAX	MIN	MAX
28	9.90	10.50	.390	.413

Reference Doc.: JEDEC Publication 95, MO-150

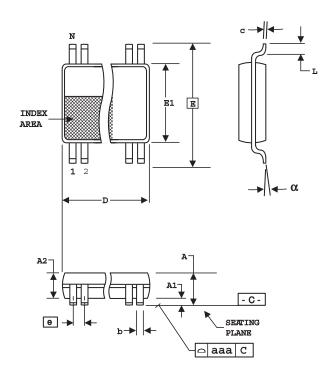
10-0033

Ordering Information

9179_¥F-03LF-T







6.10 mm. Body, 0.65 mm. Pitch TSSOP (240 mil) (25.6 mil)

SYMBOL	In Millimeters COMMON DIMENSIONS		In Inches COMMON DIMENSIONS	
	MIN	MAX	MIN	MAX
Α		1.20		.047
A1	0.05	0.15	.002	.006
A2	0.80	1.05	.032	.041
b	0.19	0.30	.007	.012
С	0.09	0.20	.0035	.008
D	SEE VARIATIONS		SEE VARIATIONS	
Е	8.10 BASIC		0.319 BASIC	
E1	6.00	6.20	.236	.244
е	0.65 BASIC		0.0256 BASIC	
L	0.45	0.75	.018	.030
N	SEE VARIATIONS		SEE VARIATIONS	
α	0°	8°	0°	8°
aaa		0.10	-	.004

VARIATIONS

N	D mm.		D (inch)	
	MIN	MAX	MIN	MAX
28	9.60	9.80	.378	.386

Reference Doc.: JEDEC Publication 95, MO-153

10-0038

Ordering Information

9179<u>y</u>G-03LF-T





Revision History

no no constructory				
Rev.	Issue Date	Description		
J	8/29/2005	Added LF Ordering Information.	9, 10	
K	12/15/2008	Removed ICS prefix from ordering information	9, 10	